



N-Channel 20-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
20	0.0049 at V _{GS} = 10 V	22	20		
	0.0061 at V _{GS} = 4.5 V	19.7	20		

FEATURES

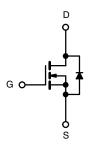
- · Halogen-free Option Available
- TrenchFET[®] Gen II Power MOSFET for Ultra Low On-Resistance



- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile
- 100 % R_a Tested

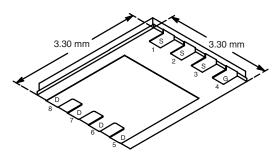
APPLICATIONS

- · Synchronous Rectification
- · Point-of-Load Converters
- Protection Devices
- Hot Swap



N-Channel MOSFET

PowerPAK 1212-8



Bottom View

Ordering Information: Si7108DN-T1-E3 (Lead (Pb)-free)

Si7108DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	ss otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	20		V
Gate-Source Voltage		V_{GS}	± 16		
Out 1 - 150 0012	T _A = 25 °C	I _D	22	14	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		17.6	11.2	
Pulsed Drain Current		I _{DM}	60		Α
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3	
Single Avalanche Current	L = 0.1 mH	I _{AS}	22		
Single Avalanche Energy	L=UIIIII	E _{AS}	24		mJ
Mariana Barra Birata di a	T _A = 25 °C	- P _D	3.8	1.5	W
Maximum Power Dissipation ^a	T _A = 70 °C		2.0	0.8	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		
Soldering Recommendations (Peak Temperature)b, c				260	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manifestory London to Application	t ≤ 10 s	- R _{thJA}	24	33	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		65	81		
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.9	2.4		

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Reliability Manual for profile. The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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Vishay Siliconix



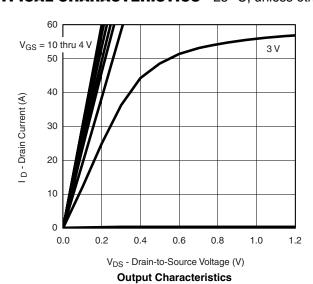
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C			1	
				5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V, I _D = 22 A		0.0041	0.0049	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 19.7 \text{ A}$		0.005	0.0061	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 22 A		88		S
Diode Forward Voltage ^a	V_{SD}	I _S = 3.2 A, V _{GS} = 0 V		0.75	1.2	V
Dynamic ^b						
Total Gate Charge	Q_g			20	30	nC
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 22 \text{ A}$		6.3		
Gate-Drain Charge	Q_{gd}			4.9		
Gate Resistance	R_g	f = 1 MHz	0.7	1.4	2.1	Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = 20 V, R_L = 20 Ω		10	15	ns
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω		60	130	
Fall Time	t _f			10	15	
Source-Drain Reverse Recovery Time t _{rr}		L = 3.2 A di/dt = 100 A/vo		30	60	
Reverse Recovery Charge	Q _{rr}	$I_F = 3.2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		20	36	nC

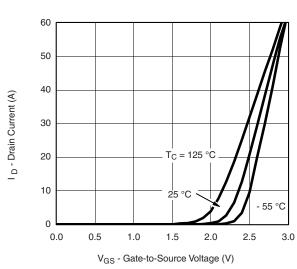
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





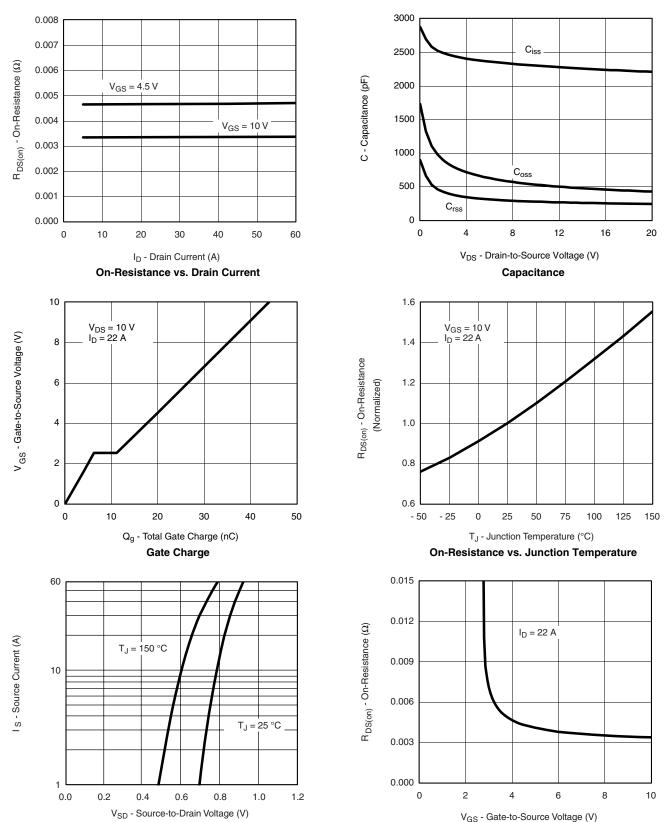
Transfer Characteristics







TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



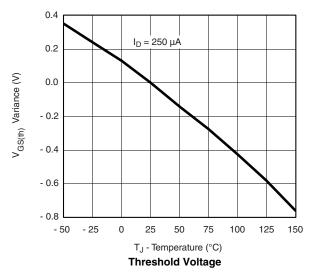
Source-Drain Diode Forward Voltage

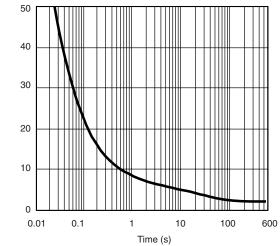
On-Resistance vs. Gate-to-Source Voltage

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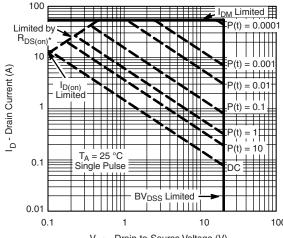
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



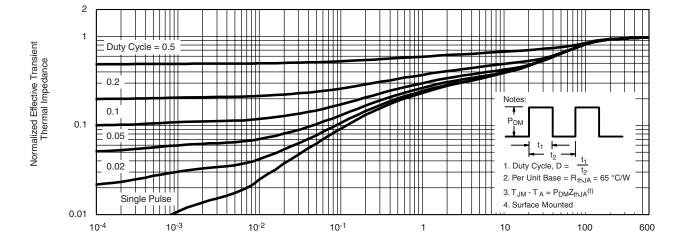


Single Pulse Power, Junction-to-Ambient



Power (W)

$$\begin{split} & V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^* V_{GS} \text{ > minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified} \\ & \textbf{Safe Operating Area} \end{split}$$

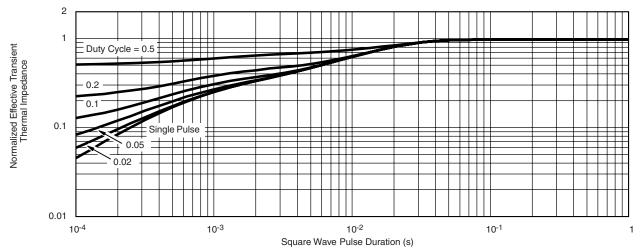


Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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